IGBT
NGTB50N60L2WG

50 A, 600 V
V_{CEsat} = 1.50 V
E_{off} = 0.6 mJ

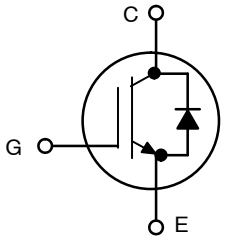
This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop (FS) Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss.

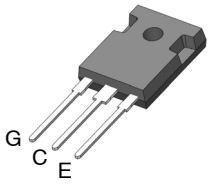
Features

- Extremely Efficient Trench with Field Stop Technology
- T_{Jmax} = 175°C
- Soft Fast Reverse Recovery Diode
- Optimized for High Speed Switching
- 5 μs Short−Circuit Capability
- These are Pb−Free Devices

Typical Applications

- Motor Drive Inverters
- Industrial Switching
- Welding





TO−247
CASE 340AM

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector−emitter Voltage	V_{CES}	600	V
Collector Current @ T_C = 25°C @ T_C = 100°C	I_C	 100 50	A
Diode Forward Current @ T_C = 25°C @ T_C = 100°C	I_F	 100 50	A
Diode Pulsed Current T_{PULSE} Limited by T_J Max	I_{FM}	200	A
Pulsed Collector Current, T_{pulse} Limited by T_{Jmax}	I_{CM}	200	A
Short−circuit Withstand Time V_{GE} = 15 V, V_{CE} = 400 V, $T_J \le$ +150°C	t_{SC}	5	μs
Gate−emitter Voltage	V_{GE}	±20	V
Transient Gate−emitter Voltage (T_{PULSE} = 5 μs, D < 0.10)		±30	V
Power Dissipation @ T_C = 25°C @ T_C = 100°C	P_D	 500 250	W
Operating Junction Temperature Range	T_J	−55 to +175	°C
Storage Temperature Range	T_{stg}	−55 to +175	°C
Lead temperature for soldering, 1/8″ from case for 5 seconds	T_{SLD}	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

MARKING DIAGRAM



50N60L2 = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week
G = Pb−Free Package

ORDERING INFORMATION

Device	Package	Shipping
NGTB50N60L2WG	TO−247 (Pb−Free)	30 Units / Rail

© Semiconductor Components Industries, LLC, 2015

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction−to−case, for IGBT	$R_{\theta JC}$	0.28	°C/W
Thermal resistance junction−to−case, for Diode	$R_{\theta JC}$	0.62	°C/W
Thermal resistance junction−to−ambient	$R_{\theta JA}$	40	°C/W

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Typ	Max	Unit
STATIC CHARACTERISTIC						
Collector−emitter breakdown voltage, gate−emitter short−circuited	V_{GE} = 0 V, I_C = 500 μA	$V_{(BR)CES}$	600	–	–	V
Collector−emitter saturation voltage	V_{GE} = 15 V, I_C = 50 A V_{GE} = 15 V, I_C = 50 A, T_J = 175°C	V_{CEsat}	1.30 –	1.50 1.85	1.80 –	V
Gate−emitter threshold voltage	V_{GE} = V_{CE}, I_C = 350 μA	$V_{GE(th)}$	4.5	5.5	6.5	V
Collector−emitter cut−off current, gate−emitter short−circuited	V_{GE} = 0 V, V_{CE} = 600 V V_{GE} = 0 V, V_{CE} = 600 V, T_J = 175°C	I_{CES}	– –	– 1.0	0.1 4.0	mA
Gate leakage current, collector−emitter short−circuited	V_{GE} = 20 V , V_{CE} = 0 V	I_{GES}	–	–	100	nA
DYNAMIC CHARACTERISTIC						
Input capacitance	V_{CE} = 20 V, V_{GE} = 0 V, f = 1 MHz	C_{ies}	–	7500	–	pF
Output capacitance		C_{oes}	–	300	–	
Reverse transfer capacitance		C_{res}	–	190	–	
Gate charge total	V_{CE} = 480 V, I_C = 50 A, V_{GE} = 15 V	Q_g	–	310	–	nC
Gate to emitter charge		Q_{ge}	–	60	–	
Gate to collector charge		Q_{gc}	–	150	–	
SWITCHING CHARACTERISTIC, INDUCTIVE LOAD						
Turn−on delay time	T_J = 25°C V_{CC} = 400 V, I_C = 50 A R_g = 10 Ω V_{GE} = 0 V/ 15 V	$t_{d(on)}$	–	110	–	ns
Rise time		t_r	–	48	–	
Turn−off delay time		$t_{d(off)}$	–	270	–	
Fall time		t_f	–	70	–	
Turn−on switching loss		E_{on}	–	1.25	–	mJ
Turn−off switching loss		E_{off}	–	0.6	–	
Total switching loss		E_{ts}	–	1.85	–	
Turn−on delay time	T_J = 150°C V_{CC} = 400 V, I_C = 50 A R_g = 10 Ω V_{GE} = 0 V/ 15 V	$t_{d(on)}$	–	115	–	ns
Rise time		t_r	–	50	–	
Turn−off delay time		$t_{d(off)}$	–	280	–	
Fall time		t_f	–	100	–	
Turn−on switching loss		E_{on}	–	1.6	–	mJ
Turn−off switching loss		E_{off}	–	1.0	–	
Total switching loss		E_{ts}	–	2.6	–	
DIODE CHARACTERISTIC						
Forward voltage	V_{GE} = 0 V, I_F = 50 A V_{GE} = 0 V, I_F = 50 A, T_J = 175°C	V_F	1.40 –	1.70 2.40	2.50 –	V
Reverse recovery time	T_J = 25°C I_F = 50 A, V_R = 200 V di_F/dt = 200 A/μs	t_{rr}	–	67	–	ns
Reverse recovery charge		Q_{rr}	–	0.30	–	μC
Reverse recovery current		I_{rrm}	–	7.4	–	A
Reverse recovery time	T_J = 175°C I_F = 50 A, V_R = 400 V di_F/dt = 200 A/μs	t_{rr}	–	143	–	ns
Reverse recovery charge		Q_{rr}	–	1.40	–	μC
Reverse recovery current		I_{rrm}	–	15	–	A

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS

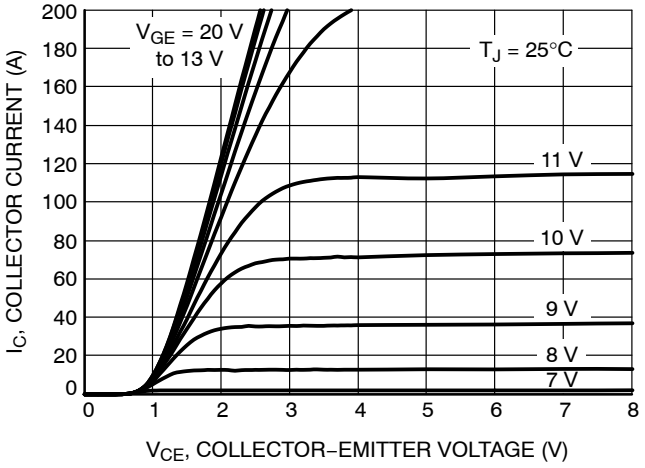


Figure 1. Output Characteristics

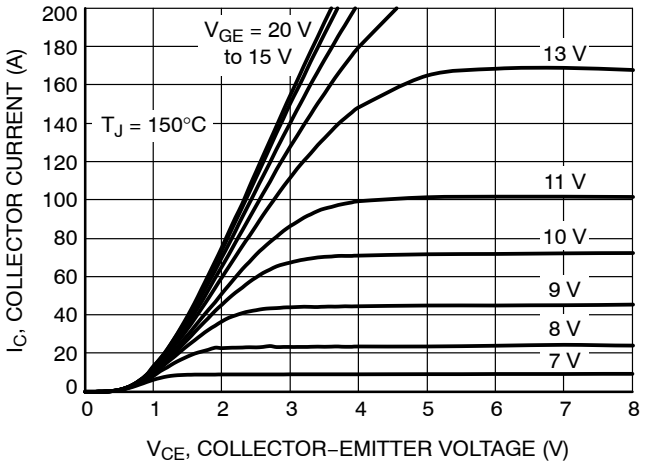


Figure 2. Output Characteristics

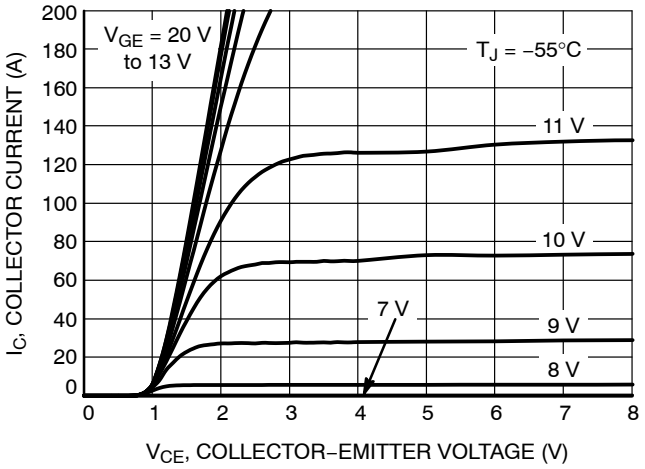


Figure 3. Output Characteristics

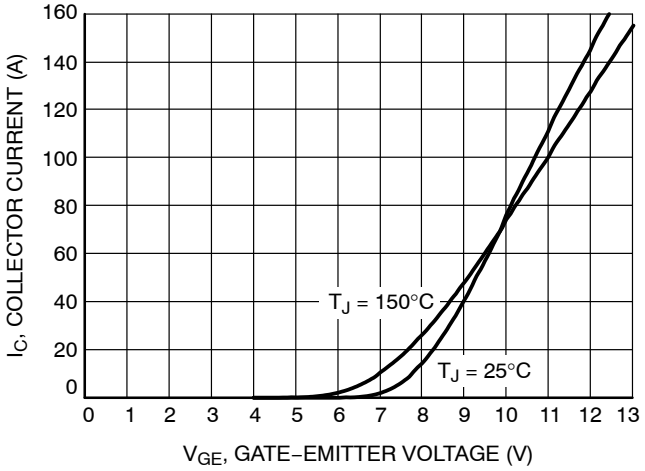


Figure 4. Typical Transfer Characteristics

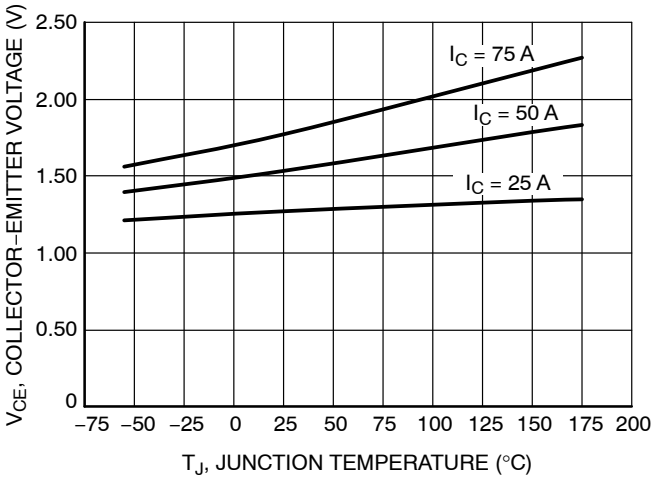


Figure 5. $V_{CE(sat)}$ vs. T_J

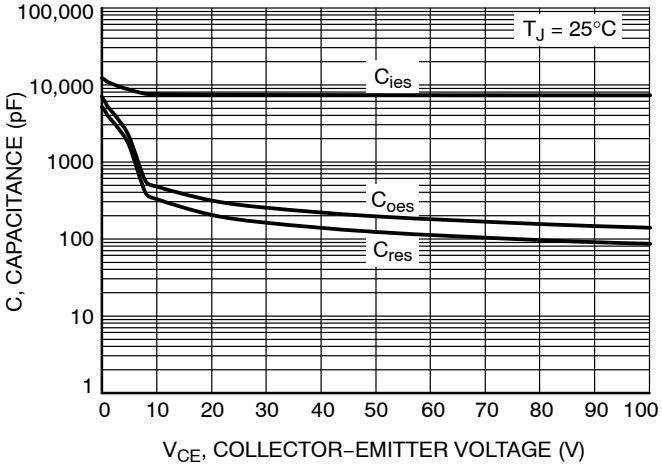


Figure 6. Typical Capacitance

TYPICAL CHARACTERISTICS

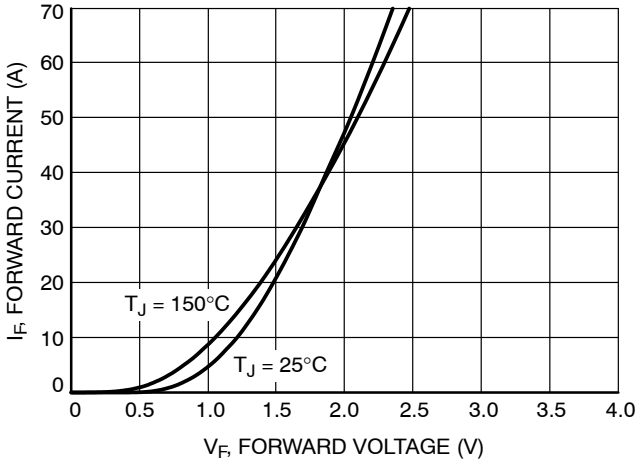


Figure 7. Diode Forward Characteristics

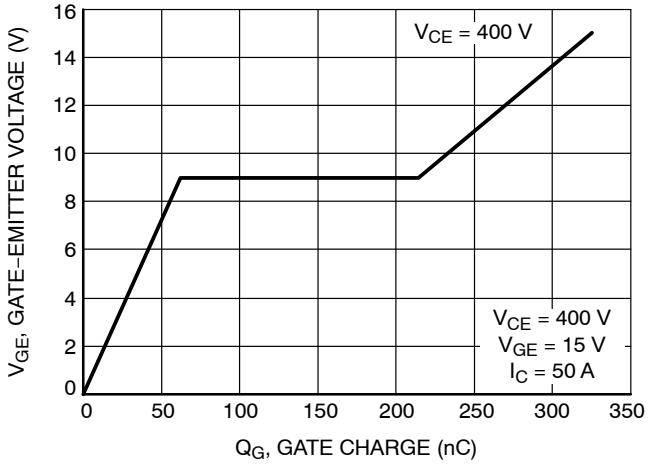


Figure 8. Typical Gate Charge

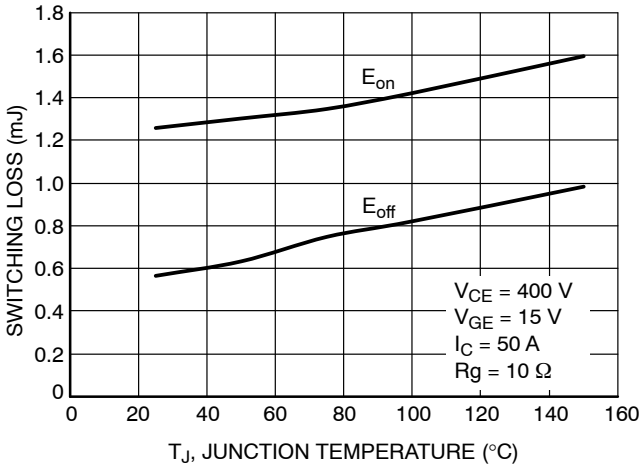


Figure 9. Switching Loss vs. Temperature

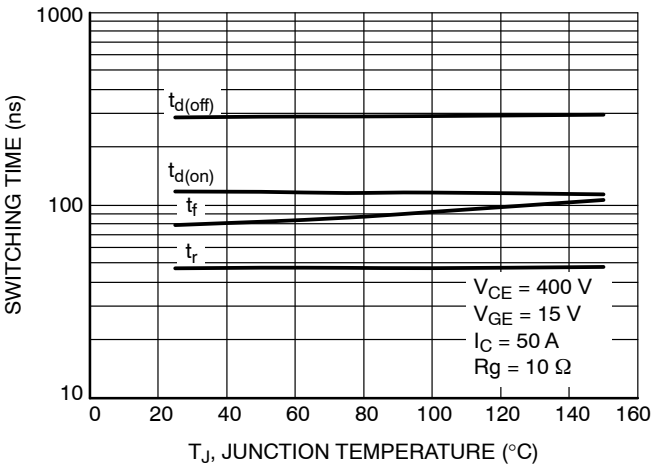


Figure 10. Switching Time vs. Temperature

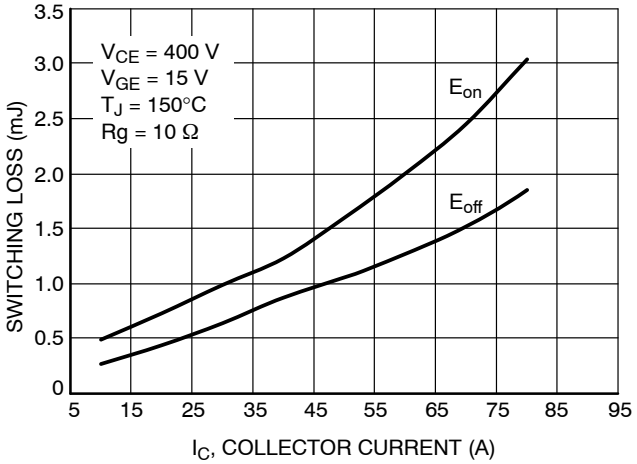


Figure 11. Switching Loss vs. I_C

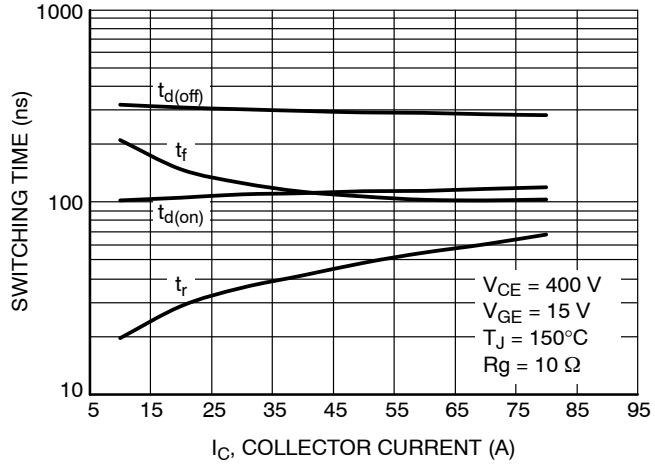


Figure 12. Switching Time vs. I_C

TYPICAL CHARACTERISTICS

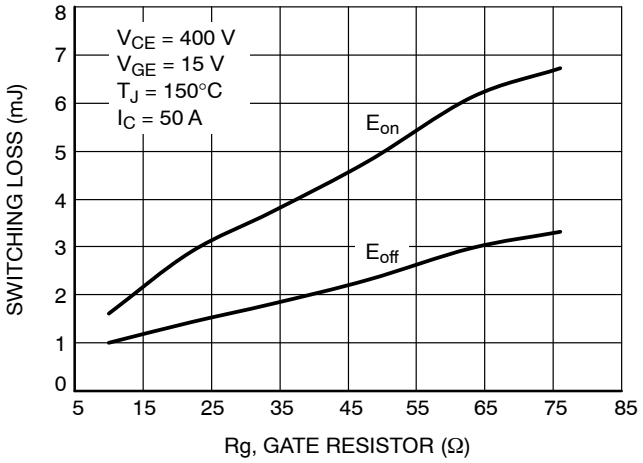


Figure 13. Switching Loss vs. Rg

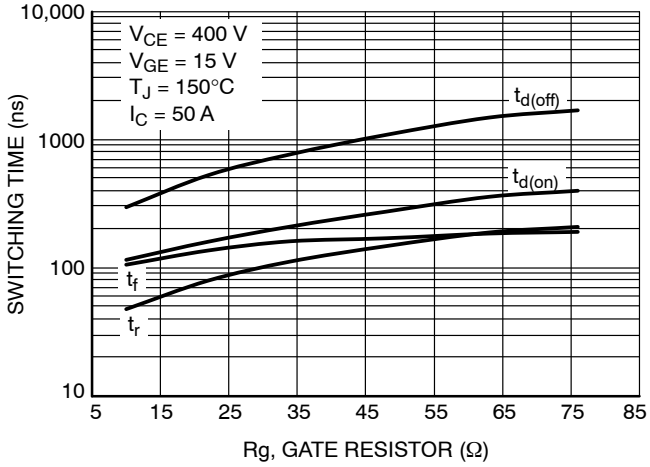


Figure 14. Switching Time vs. Rg

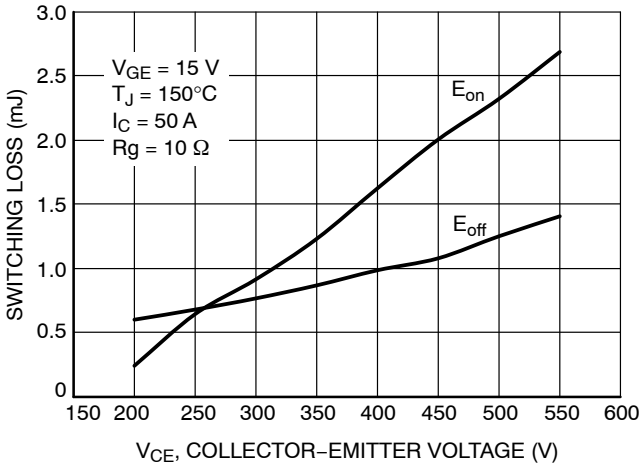


Figure 15. Switching Loss vs. V_{CE}

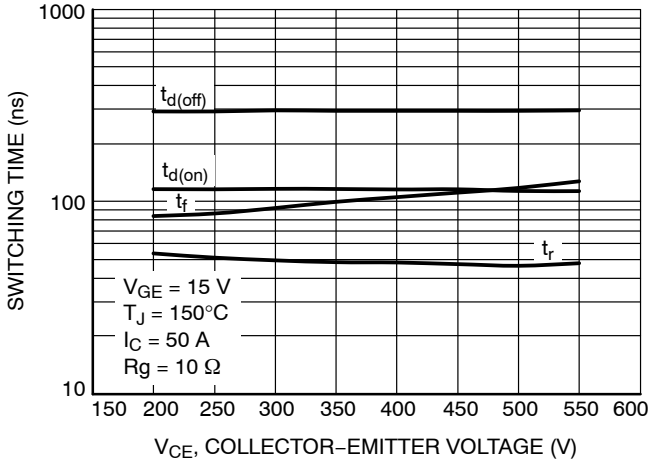


Figure 16. Switching Time vs. V_{CE}

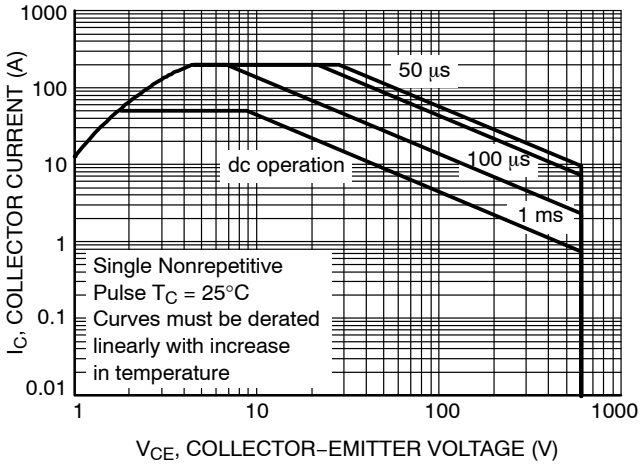


Figure 17. Safe Operating Area

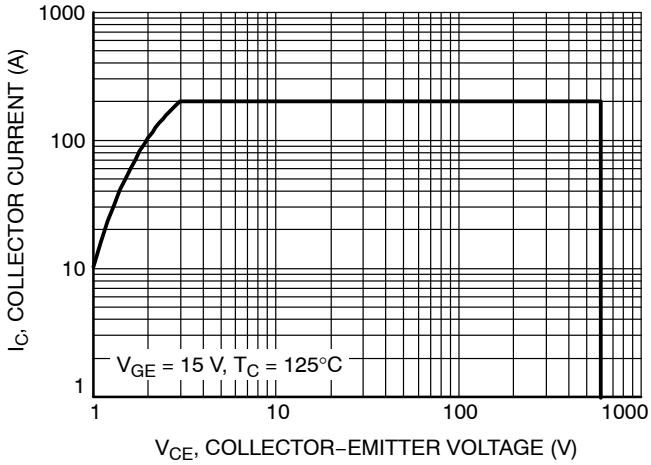


Figure 18. Reverse Bias Safe Operating Area

TYPICAL CHARACTERISTICS

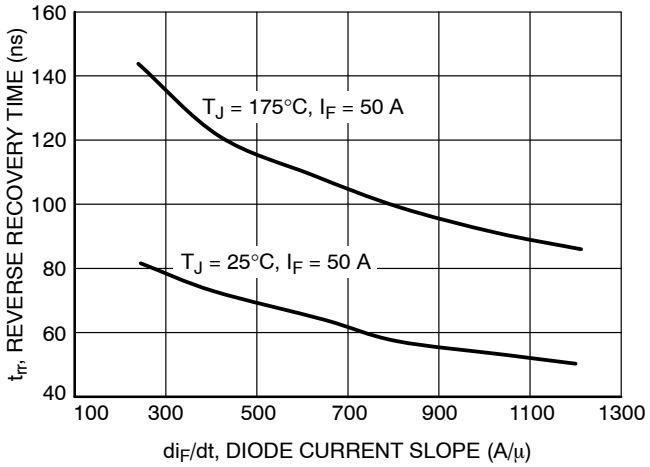


Figure 19. t_{rr} vs. di_F/dt (V_R = 400 V)

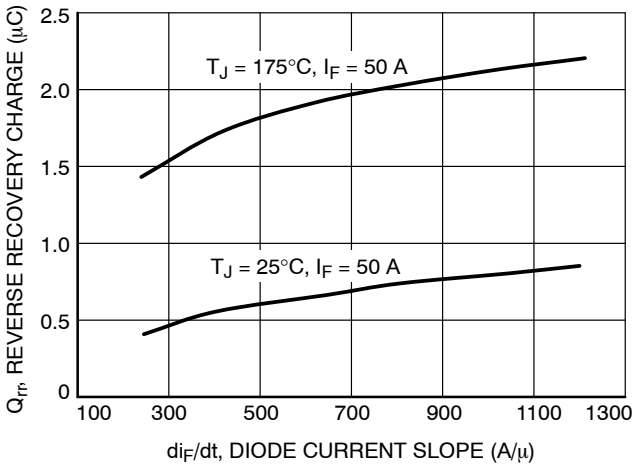


Figure 20. Q_{rr} vs. di_F/dt (V_R = 400 V)

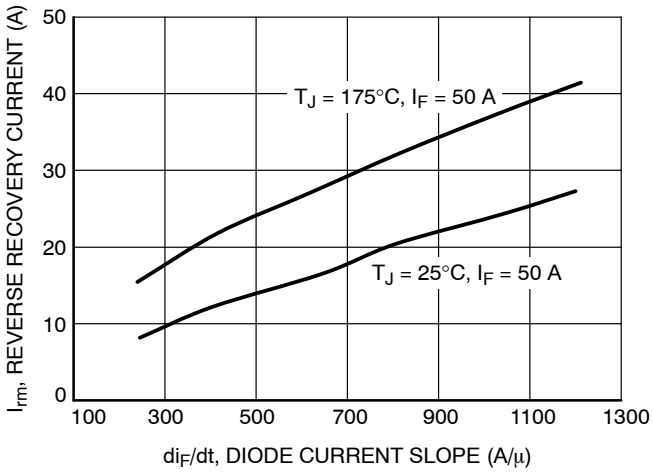


Figure 21. I_{rm} vs. di_F/dt (V_R = 400 V)

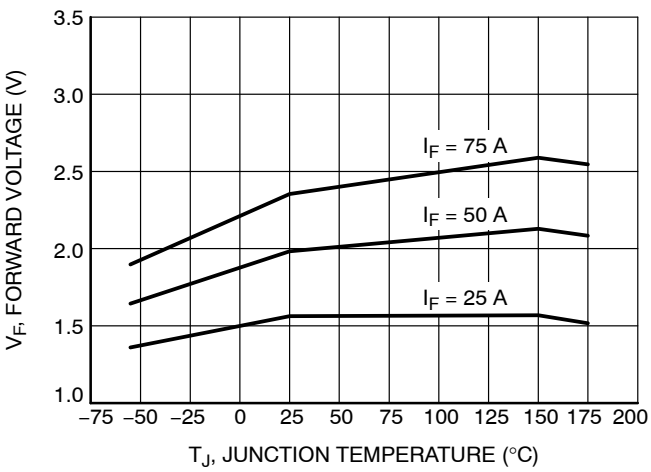
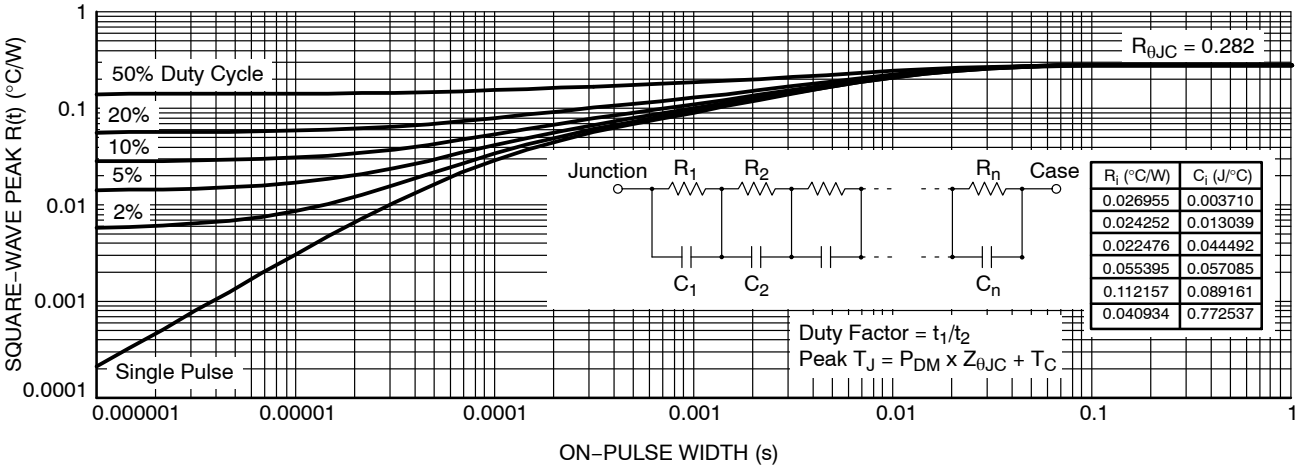


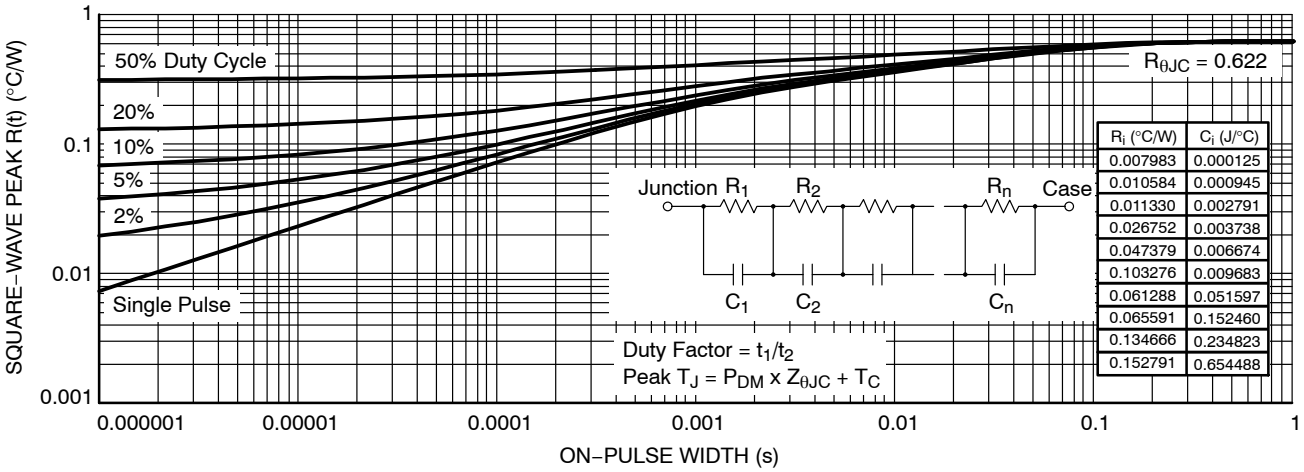
Figure 22. V_F vs. T_J

TYPICAL CHARACTERISTICS



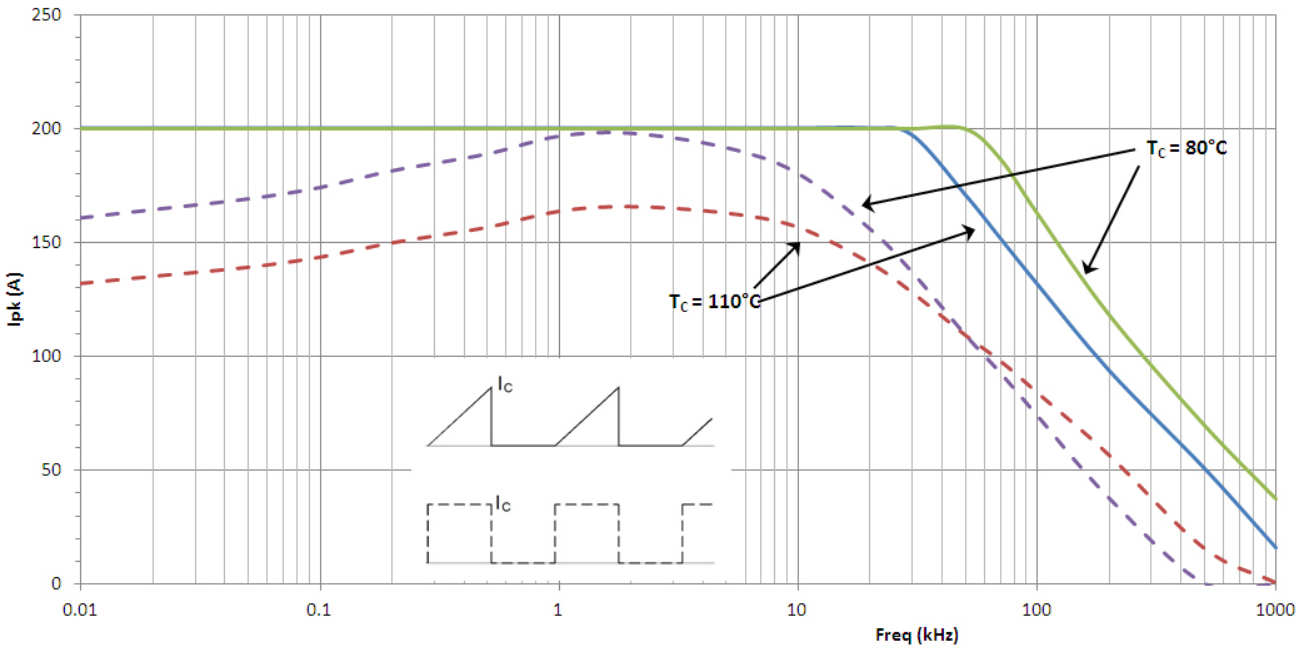
R_i (°C/W)	C_i (J/°C)
0.026955	0.003710
0.024252	0.013039
0.022476	0.044492
0.055395	0.057085
0.112157	0.089161
0.040934	0.772537

Figure 23. IGBT Transient Thermal Impedance



R_i (°C/W)	C_i (J/°C)
0.007983	0.000125
0.010584	0.000945
0.011330	0.002791
0.026752	0.003738
0.047379	0.006674
0.103276	0.009683
0.061288	0.051597
0.065591	0.152460
0.134666	0.234823
0.152791	0.654488

Figure 24. Diode Transient Thermal Impedance



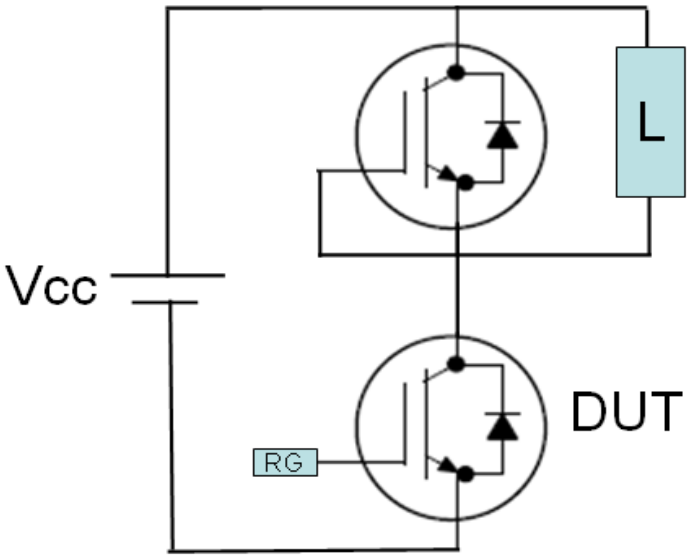


Figure 25. Test Circuit for Switching Characteristics

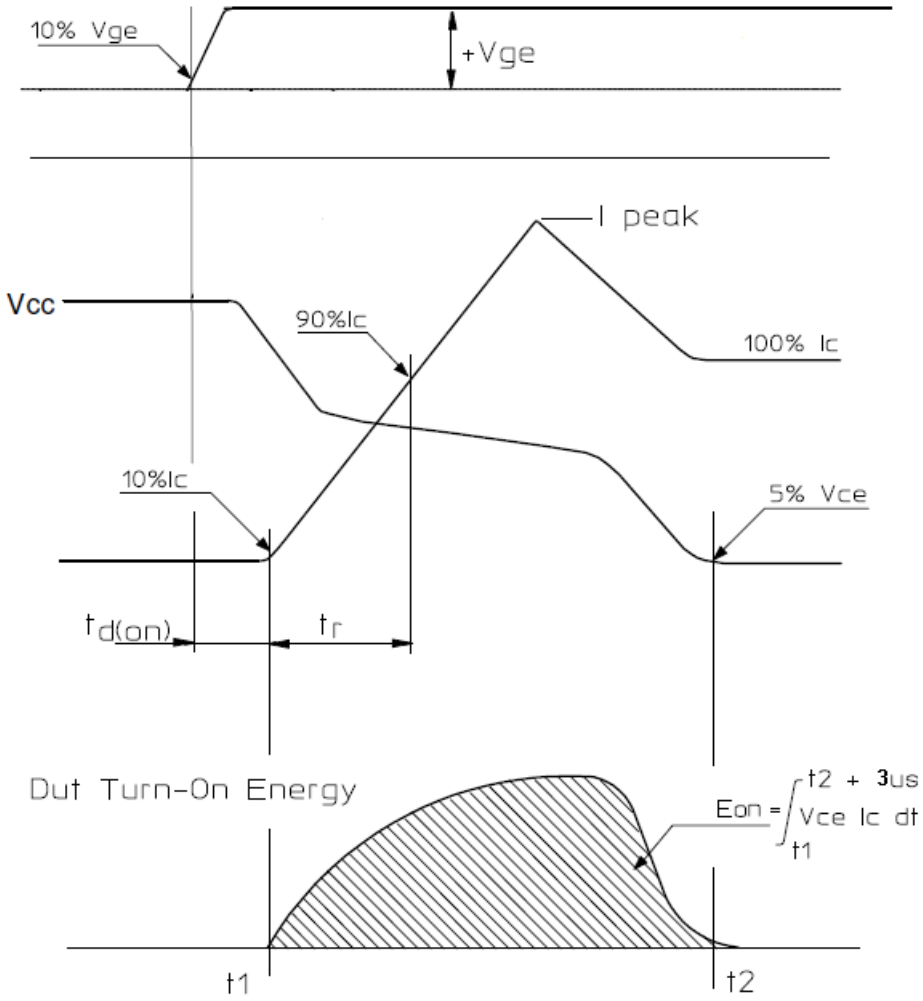


Figure 26. Definition of Turn On Waveform

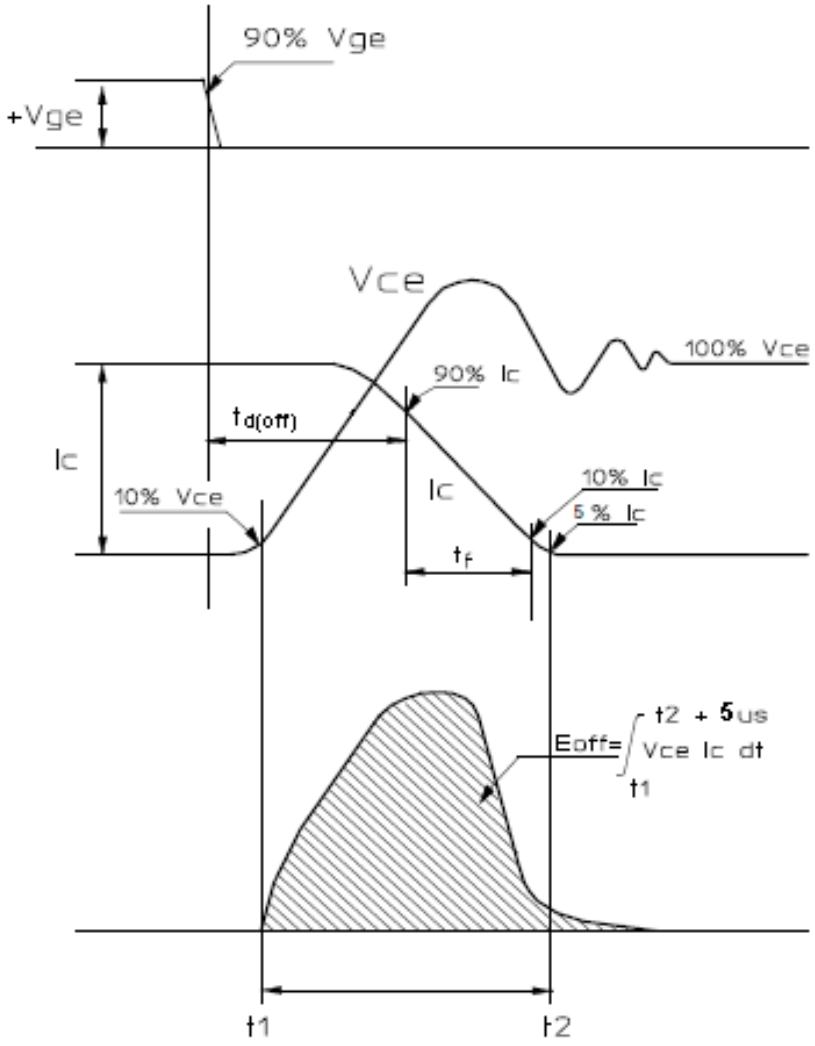
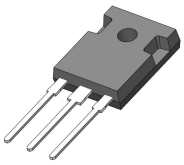
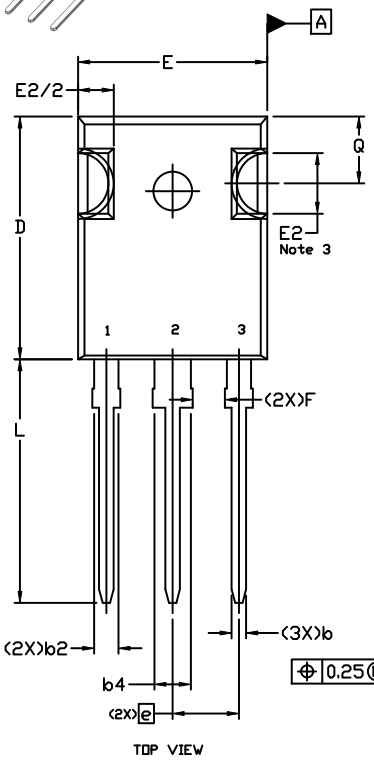


Figure 27. Definition of Turn Off Waveform

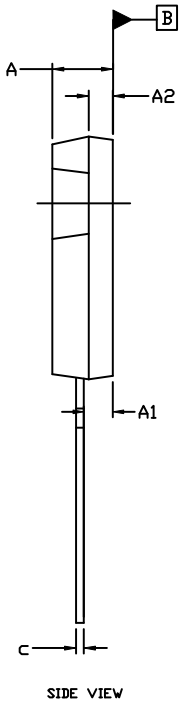


TO−247
CASE 340AM
ISSUE C

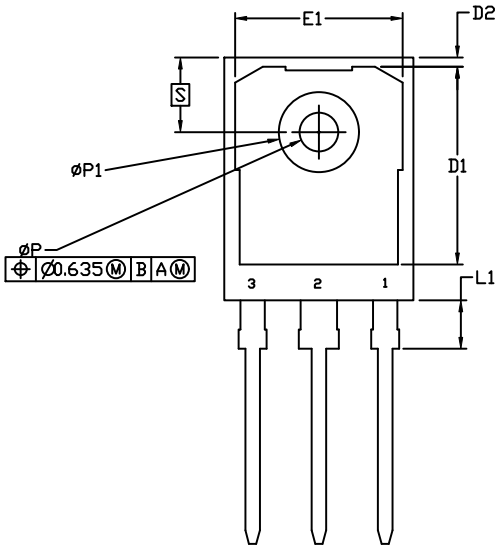
DATE 07 SEP 2021



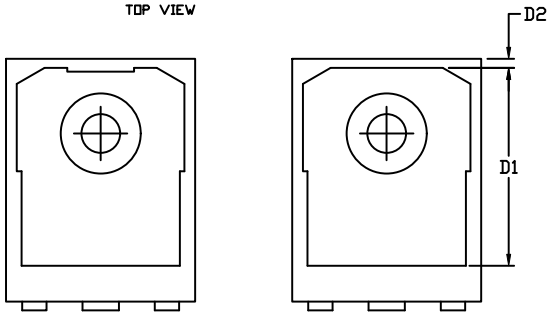
TOP VIEW



SIDE VIEW



BACK VIEW



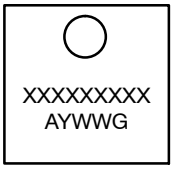
NOTE 4 HEATSINK SHAPES

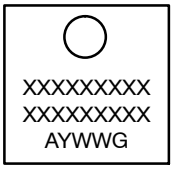
DIM	MILLIMETERS		
	MIN	NOM	MAX
A	4.70	5.00	5.30
A1	2.20	2.40	2.60
A2	1.80	2.00	2.20
b	1.07	1.20	1.33
b2	1.65	2.12	2.35
b4	2.60	3.12	3.40
c	0.45	0.60	0.75
D	20.80	21.00	21.34
D1	16.30	---	---
D2	0.75	---	---
E	15.50	16.00	16.25
E1	13.80	---	---
E2	4.32	4.90	5.49
e	5.45 BSC		
F	2.655	---	---
L	19.80	20.00	20.80
L1	3.81	4.20	4.35
P	3.55	3.60	3.65
P1	6.60	---	---
Q	5.40	6.00	6.20
S	6.15 BSC		

NOTES:

1. DIMENSIONING AND TOLERANCE AS PER ASME Y14.5M, 2009.
2. ALL DIMENSION ARE IN MILLIMETERS.
3. SLOT REQUIRED, NOTCH MAY BE ROUNDED.
4. OPTIONAL BACK SIDE HEATSINK SHAPE.
5. DIMENSIONS ARE EXCLUSIVE OF BURRS AND MOLD FLASH. DIMENSIONS D AND E ARE MEASURED AT THE OUTERMOST EXTREME OF THE PLASTIC BODY.
6. DIMENSIONS A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
7. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

GENERIC MARKING DIAGRAMS*





XXXX = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week
G = Pb−Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, “G” or microdot “▪”, may or may not be present. Some products may not follow the Generic Marking.

DOCUMENT NUMBER:	**98AON77284F**	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped “CONTROLLED COPY” in red.
DESCRIPTION:	**TO−247**	**PAGE 1 OF 1**

onsemi and onsemi are trademarks of Semiconductor Components Industries, LLC dba **onsemi** or its subsidiaries in the United States and/or other countries. **onsemi** reserves the right to make changes without further notice to any products herein. **onsemi** makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. **onsemi** does not convey any license under its patent rights nor the rights of others.

onsemi, , and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "**onsemi**" or its affiliates and/or subsidiaries in the United States and/or other countries. **onsemi** owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of **onsemi**'s product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent−Marking.pdf. **onsemi** reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as−is" and **onsemi** makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:
Technical Library: www.onsemi.com/design/resources/technical−documentation
onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support
For additional information, please contact your local Sales Representative at www.onsemi.com/support/sales

ENTEGRECİ

Bu belge www.entegreci.com üzerinden sunulmaktadır.

Elektronik komponent tedarikinde Entegreci

Entegreci, Eskişehir merkezli, Türkiye geneline satış yapan bir elektronik komponent mağazasıdır. Entegreler (IC), mikrodenetleyiciler, transistörler, diyotlar, pasif elemanlar, konnektörler, modüller ve geliştirme kartları tek adetten seri üretim adetlerine kadar satılır. Ürün sayfalarında güncel stok durumunu, fiyatı ve datasheet bağlantısını bulabilirsiniz.

Parça koduyla arama

Üretici parça numarasını yazın; stok ve fiyatı hemen görün.

www.entegreci.com

Ürün kategorileri

Entegreden kapasitöre tüm elektronik komponent kategorileri.

Kategorilere göz atın

Üreticiler

Aradığınız üreticinin ürünlerini tek sayfada inceleyin.

Üreticileri görün

Toplu alım ve teklif

Listede olmayan ya da yüksek adetli parçalar için teklif isteyin.

Teklif isteyin

www.entegreci.com | **destek@entegreci.com** | **0850 305 90 34**

Entegreci is an online electronic components store based in Türkiye. Search by manufacturer part number to see stock, prices and datasheets for integrated circuits, microcontrollers, transistors, passive components and connectors, or request a quote for parts that are not listed.

Bu sayfa Entegreci tarafından eklenmiştir. Belgenin önceki sayfaları asıl yayıncısına aittir ve içeriği değiştirilmemiştir; en güncel sürüm için belgenin yayıncısına başvurun.